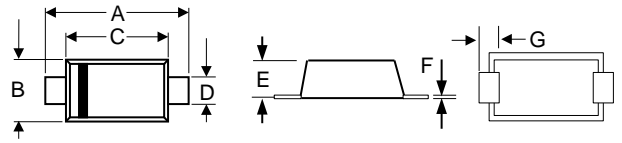


### Features

- \* For surface mounted application
- \* Extremely low thermal resistance
- \* Easy pick and place
- \* High temp soldering: 260°C for 10 seconds at terminals
- \* Fast reverse recovery time



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DIM.	SMAF			
	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.173	0.193	4.40	4.90
B	0.094	0.106	2.40	2.70
C	0.130	0.146	3.30	3.70
D	0.051	0.063	1.30	1.60
E	0.035	0.043	0.90	1.10
F	0.005	0.008	0.12	0.20
G	0.031	0.047	0.80	1.20

### Mechanical Data

- \* Case: SMAF Molded plastic
- \* Terminals: Solderable per MIL-STD-750, Method 2026
- \* Polarity: Indicated by cathode band

### Maximum Ratings and Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Type Number	Symbols	FS3AA	FS3BA	FS3DA	FS3GA	FS3JA	FS3KA	FS3MA	Unit
		F	F	F	F	F	F	F	
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum D.C Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current	I <sub>F(AV)</sub>	3							A
Peak Forward Surge Current, 8.3ms single half sine-wave	I <sub>FSM</sub>	100							A
Maximum Instantaneous Forward Voltage at 3.0A	V <sub>F</sub>	1.3							V
Maximum D.C Reverse Current @ T <sub>J</sub> =25°C	I <sub>R</sub>	5							μA
at Rated D.C Blocking Voltage @ T <sub>J</sub> =125°C		100							
Maximum Reverse Recovery Time (Note1)	T <sub>rr</sub>	150			250	500		nS	
Typical Junction Capacitance (Note2)	C <sub>J</sub>	32							pF
Typical Thermal Resistance (Note3)	R <sub>θJA</sub>	50							°C/W
	R <sub>θJC</sub>	16							
Operating Junction Temperature Range	T <sub>J</sub>	-55 to +150							°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150							°C

Note 1: Reverse Recovery Test Conditions: I<sub>F</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>RR</sub>=0.25A

Note 2: Measured at 1MHz and applied reverse voltage of 4.0V D.C.

Note 3: P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

### Ratings and Characteristic Curves

Fig.1 Maximum Average Forward Current Rating

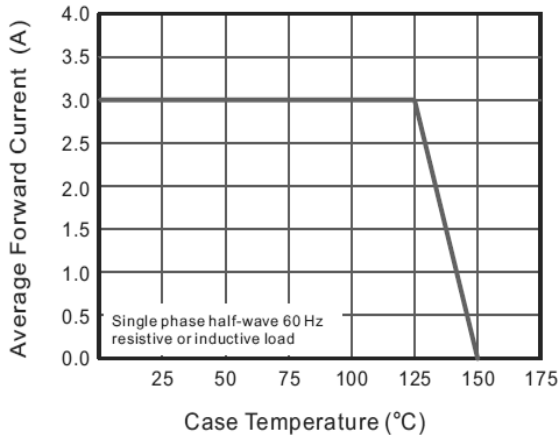


Fig.2 Typical Reverse Characteristics

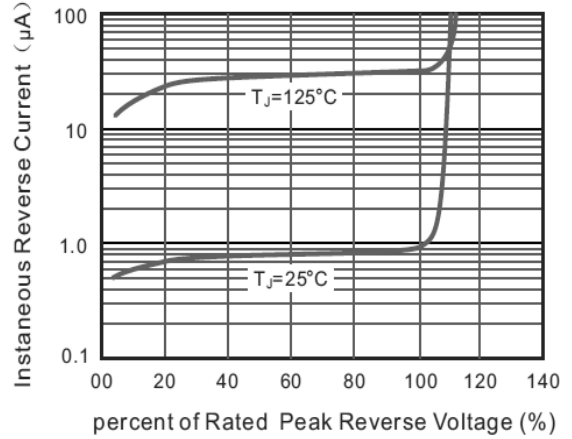


Fig.3 Typical Instantaneous Forward Characteristics

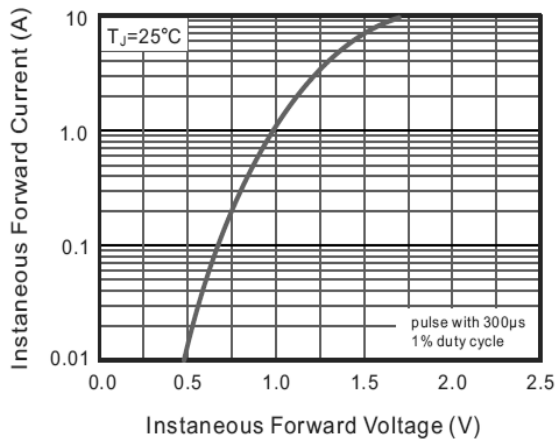


Fig.4 Typical Junction Capacitance

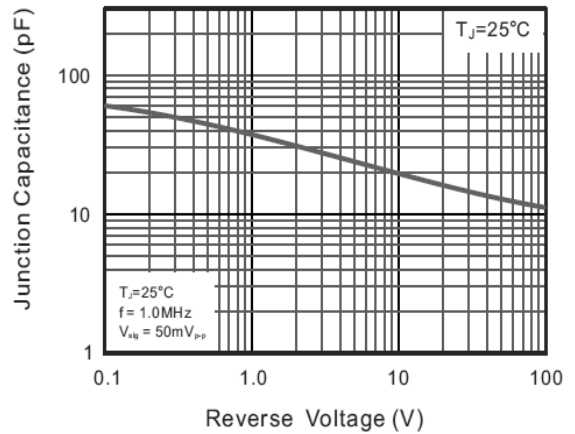
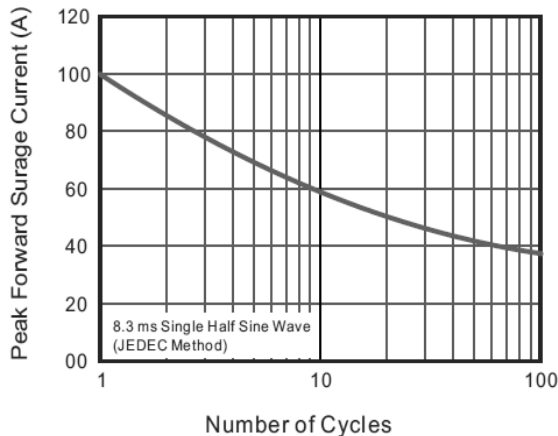


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current





# FS3AAF THRU FS3MAF

## Surface Mount Glass Passivated Fast Recovery Rectifiers

### Ordering Information

Part No.	Package	Packing Code	Packing
FS3AAF THRU FS3MAF	SMAF	R30	3000pcs/Reel

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